501839199 03/02/2012

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yutaka HOSHINO	12/15/2011

RECEIVING PARTY DATA

Name:	Renesas Electronics Corporation	
Street Address:	1753, Shimonumabe, Nakahara-ku,	
City:	Kawasaki-shi, Kanagawa	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13409728

CORRESPONDENCE DATA

Fax Number: (703)610-8686 Phone: 7036108652

Email: dminter@milesstockbridge.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

 $\neg \vdash$

via US Mail.

Correspondent Name: Mitchell W. Shapiro

Address Line 1: 1751 Pinnacle Drive, Suite 500
Address Line 4: McLean, VIRGINIA 22102-3833

ATTORNEY DOCKET NUMBER:	XA-12078/T3844-18782US01	
NAME OF SUBMITTER:	Dawn Minter	

Total Attachments: 1

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PATENT REEL: 027794 FRAME: 0675 \$40.00 1340972

ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Electronics Corporation,

a corporation organized under the laws of Japan,

located at 1753. Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Electronics Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

MANUFACTURING METHOD OF SEMICONDUCTOR DEVICE AND SEMICONDUCTOR DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Electronics Corporation,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing. continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Electronics Corporation,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) (発明者フルネームサイン)		Date Signed (署名日)	
1)	yutaka Hashiro Yutaka HOSHINO	Documber 15, 2011	
2)			
3)			
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5)			
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7)		,	
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PATENT REEL: 027794 FRAME: 0676

RECORDED: 03/02/2012